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Part Number: [0442480094](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Inverted, 6/6, 2 Ports

Documents:
[3D Model](#) [Product Specification PS-43860-003 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

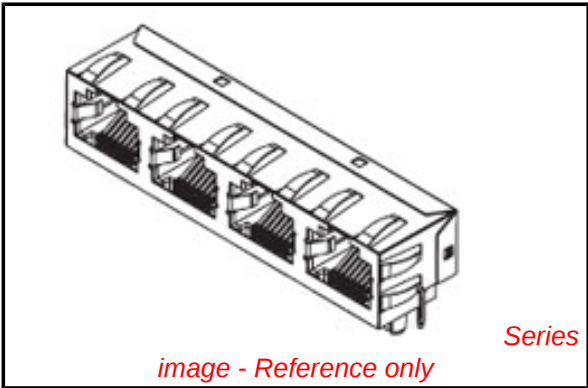
CSA LR19980
UL E107635

General

Product Family Modular Jacks/Plugs
Series [44248](#)
Comments Industry Compatible
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ11

Physical

Boot Color N/A
Color - Resin Black
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch Yes
Lightpipes/LEDs None
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin Polyester
Orientation Right Angle (Side Entry)
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.57 mm
Packaging Type Tray
Pitch - Mating Interface (in) 0.040 In
Pitch - Mating Interface (mm) 1.02 mm
Pitch - Term. Interface (in) 0.040 In
Pitch - Term. Interface (mm) 1.02 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 2
Positions / Loaded Contacts 6/4
Surface Mount Compatible (SMC) No
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Waterproof / Dustproof No
Wire/Cable Type N/A



EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Not Reviewed
**Halogen-Free
Status**

Not Reviewed

**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

China RoHS



Search Parts in this Series
[44248Series](#)

Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Shielded	Yes
Voltage - Maximum	150V AC (RMS)

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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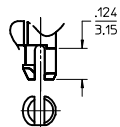
Material Info

Reference - Drawing Numbers

Packaging Specification	PK-44248-004
Product Specification	PS-43860-003, RPS-43860-004, RPS-43860-007, RPS-43860-008, RPS-43860-013
Sales Drawing	SD-44248-001

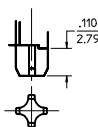
This document was generated on 06/08/2010

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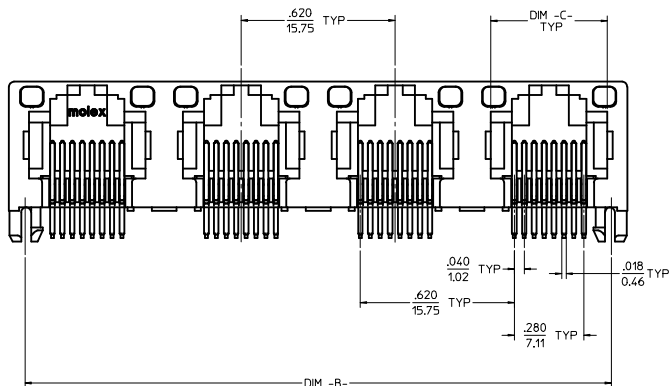
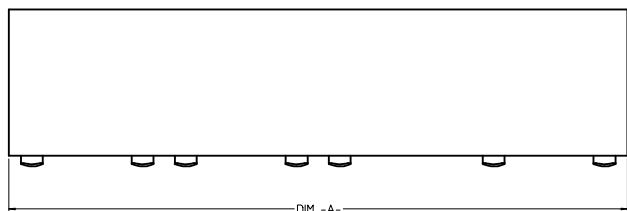
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8

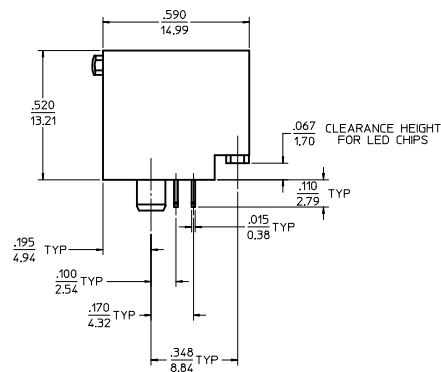


(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



UNSHIELDED
WITH LIGHT PIPES



8 CIRCUIT HOUSING(S)

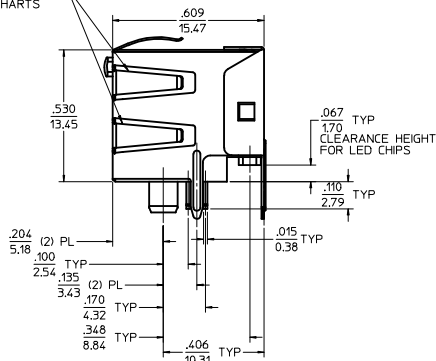
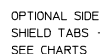
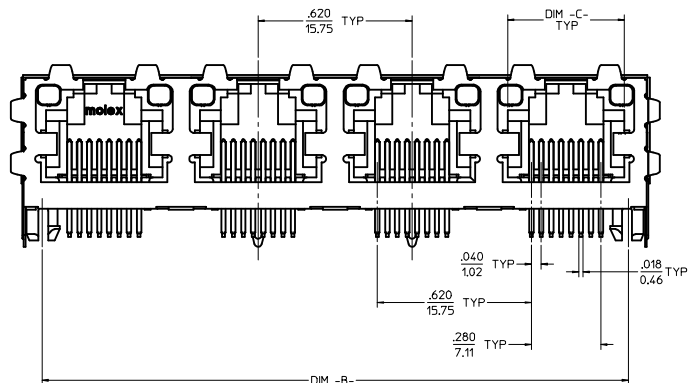
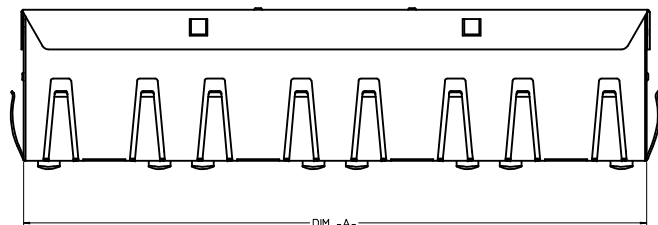
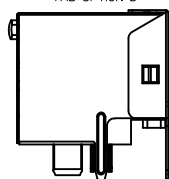
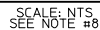
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0001	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0002	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0005	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0006	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0009	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0010	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0011	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0012	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0017	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0018	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0019	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0020	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
 - FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
 - APPLICATION SPECIFICATION: AS-43860-001
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

CHGD 0117 TO 0119 EC NO: UCP2009-1482 DRAWN BY: KLOSTER 2008/12/10 CHKD BY: IELL 2008/12/10 APPR:FSM TH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED):		DIMENSION STYLE		SCALE	DESIGN UNITS	 THIRD ANGLE PROJECTION	TITLE
				IN/MM		4:1	INCH		
		mm INCH		DRAWN BY	DATE	GANGED INVERTED MODJACK ASSEMBLY			
		4 PLACES ±--- ±---		CHECKED BY	DATE				
		3 PLACES ±--- ±.010		JROBERTS	98/10/06				
		2 PLACES ±0.25 ±---		APPROVED BY	DATE				
		1 PLACE ±--- ±---		JROBERTS	98/10/06				
		ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-44248-001			
				SIZE D THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO. 1 OF 6			



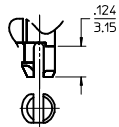
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0029	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0030	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
44248-0033	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
44248-0034	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0037	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0038	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0039	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0040	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0045	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0046	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0047	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0048	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

- NOTES:
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICRONS (1.27 MICROMETERS) MIN.
SELECT TIN IN PC TAIL AREA: 100 MICRONS (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICRONS (1.27 MICROMETERS) MIN.
SHIELD:
100 MICRONS (2.54 MICROMETERS) NICKEL OVER 50 MICRONS (1.27 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
3) PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS"
DIRECTIVE 2002/95/EC AND ELV ANNEX H OF DIRECTIVE 2000/53/EC."
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PCS-44248-004.
 - 5) APPLICATION SPECIFICATION: AS-43860-001
 - 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - 8) MOD JACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - 10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

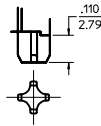
SHIELDED
WITH LIGHT PIPES

SEE SHEET 1 EC NO: UCP2009-1482 DRAWING: MJDSTEM-EPER 2008/12/10 CHKD: BELL APPR: J.S.H.T.H. 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
	 	mm	INCH	DRAWN BY	DATE	TITLE	4:1	INCH		
	4 PLACES	±---	±---	MAYO	98/10/06	GANGED INVERTED				
	3 PLACES	±---	±.010	CHECKED BY	DATE	MODJACK ASSEMBLY				
	2 PLACES	±0.25	±---	JOBERTS	98/10/06					
	1 PLACE	±---	±---	APPROVED BY	DATE					
	ANGULAR ±1/2°			JOBERTS	98/10/06	 MOLEX INCORPORATED				
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.				SHEET NO.	
			SEE CHART		SD-4428-001				2 OF 6	
			SIZE 		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



SNAP-FIT PEG OPTION

SCALE: NTS
SEE NOTE #7



PRESS-FIT PEG OPTION

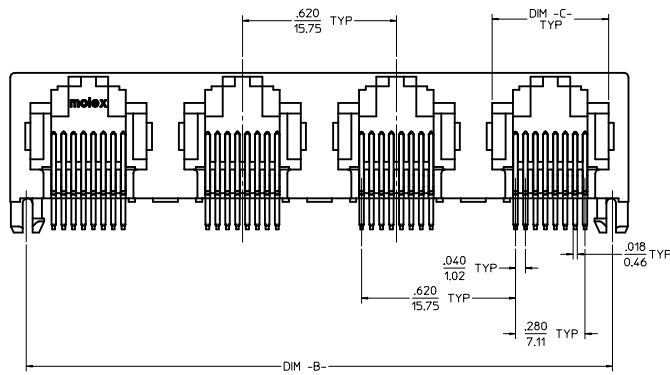
SCALE: NTS
SEE NOTE #7

8 CIRCUIT HOUSING(S)

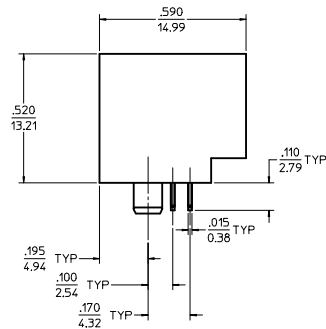
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0057	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0058	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0061	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0062	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0065	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0066	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0067	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0068	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0073	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0074	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0075	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0076	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88



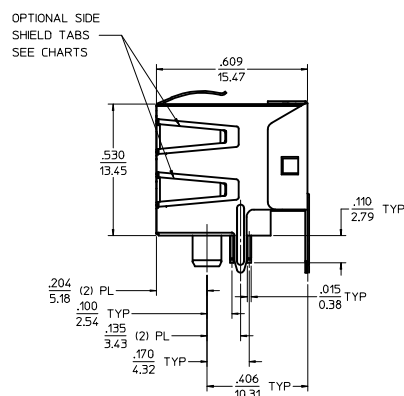
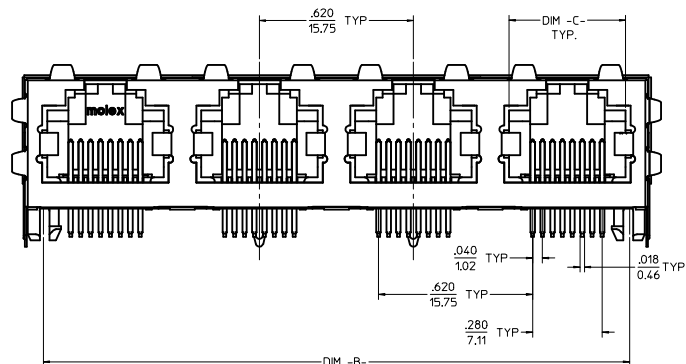
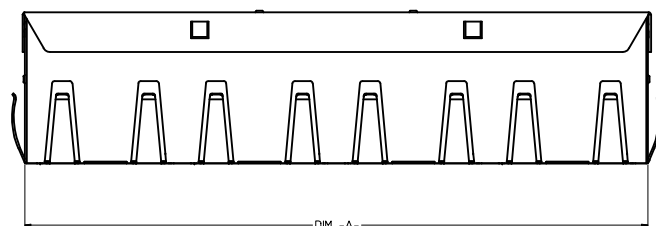
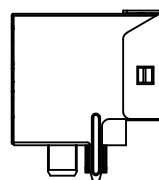
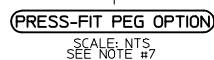
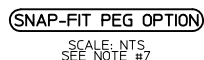
UNSHIELDED



- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
 - FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

SEE SHEET 1 EC NO: UCP2009-1482 DRAWN: KLOSTERMEIER 2008/12/10 CHKD: J.BELL 2008/12/10 APPROVED: SMITH 2008/12/10	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
		4 PLACES ± .010 3 PLACES ± .010 2 PLACES ± 0.25 1 PLACE ± .010		DRAWN BY MAYO 98/10/06 CHECKED BY JROBERTS 98/10/06 APPROVED BY JROBERTS 98/10/06		TITLE GANGED INVERTED MODJACK ASSEMBLY		
		ANGULAR ±1/2°		MATERIAL NO. SEE CHART		MOLEX INCORPORATED		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE D		DOCUMENT NO. SD-44248-001		

SHEET NO.
3 OF 6



(8) CIRCUIT HOUSING(S)								
X = NOT TOOLED	ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
	44248-0085	8	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0086	8	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
	44248-0089	8	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.469/11.92
	44248-0090	8	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.469/11.92
X	44248-0119	8	4	PRESS FIT	B	2.514/63.86	2.360/59.94	.469/11.92

(6) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
42248-0093	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0094	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0095	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0096	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0101	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0102	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
42248-0103	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
42248-0104	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

- NOTES:
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - 2) FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICRONS (127 MICROMETERS) MIN.
*SELECT TIN IN PCB TAIL AREA: 100 MICRONS (254 MICROMETERS) MIN.
*WITH OVERALL NICKEL UNDERPLATE: 50 MICRONS (127 MICROMETERS) MIN.
SHIELD:
*100 MICRONS (254 MICROMETERS) NICKEL OVER 50 MICRONS (127 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX I OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PCB TAILS AVOIDER SHIELD.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-42248-004.
 - 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - 7) MOD JACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 8) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5 AND 6).
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-49-002.

SHIELDED

CHGD 0117 TO 0119 ECN NO. IJC2003-1482 DRAWING KLOSTENLER 2008/12/10 CHYKJ:BNH 2008/12/10 APPR:FSM 2008/12/10			QUALITY SYMBOLS ▽=0 ▽=0		GENERAL TOLERANCES (UNLESS SPECIFIED) mmINCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± .025 ± --- 1 PLACE ± ± --- ANGULAR ±1/2°		DIMENSION STYLE IN/MM DRAWN BY MMYAO 98/10/06 CHECKED BY JROBERTS 98/10/06 APPROVED BY JROBERTS 98/10/06		SCALE 4:1 DESIGN UNITS INCH THIRD ANGLE PROJECTION		TITLE GANGED INVERTED MODJACK ASSEMBLY		MOLEX MOLEX INCORPORATED		MATERIAL NO. DOCUMENT NO. SD-44248-001		SHEET NO. 4 OF 6	
REV		DESCRIPTION		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS														
REV		DESCRIPTION		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION														



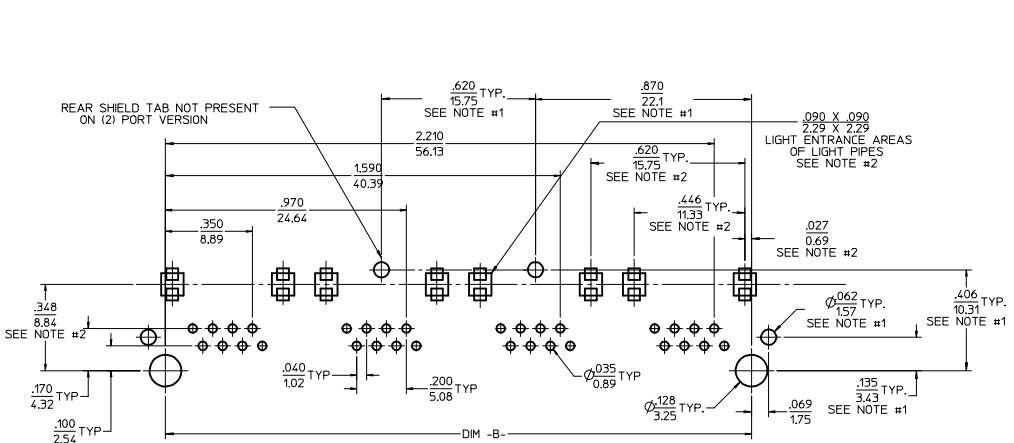
NOTES:

- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH THE SHIELDING OPTION INCLUDED
- 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
- 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

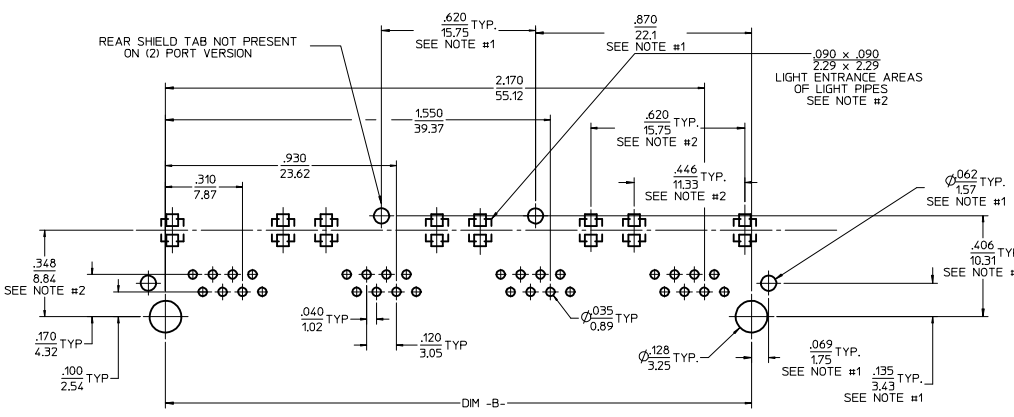
TYPICAL PC TERMINAL HOLE LAYOUT
(8) CIRCUIT CONFIGURATION
SCALE: 10:1

ib_frame_D_P_AM_T
Rev. E 2006/04/15

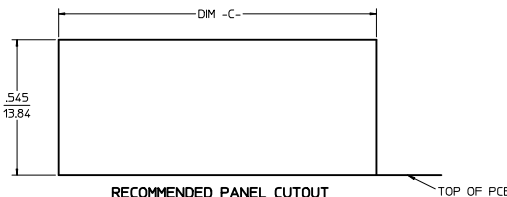
20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1



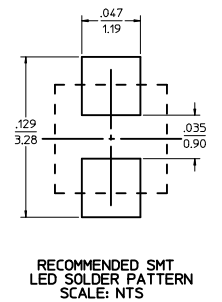
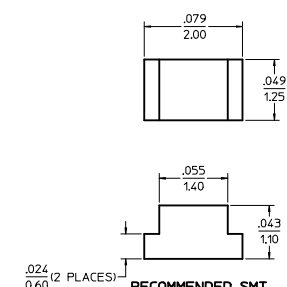
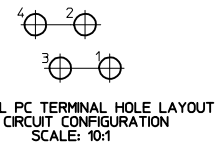
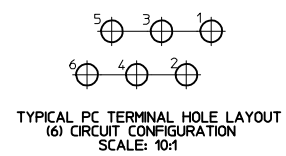
6 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



4 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



- NOTES:
- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH SHIELDING OPTION INCLUDED
 - 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
 - 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED): mm INCH 4 PLACES ±.010 3 PLACES ±.010 2 PLACES ±.025 1 PLACE ±.050 ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
			DRAWN BY MMAYO		DATE 98/10/06	TITLE GANGED INVERTED MODJACK ASSEMBLY	
			CHECKED BY JROBERTS		DATE 98/10/06	APPROVED BY JROBERTS	
			DATE 98/10/06		MATERIAL NO. N/A		
DOCUMENT NO. SD-44248-001		SHEET NO. 6 OF 6		MOLEX INCORPORATED			

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru

www.lifeelectronics.ru